onsemi

MOSFET - Power, Single N-Channel, SO8-FL 30 V, 1.15 mΩ, 245 A

NTMFS1D15N03CG

Features

- Advanced Package (5x6 mm) with Excellent Thermal Conduction
- Ultra Low R_{DS(on)} to Improve System Efficiency
- These Devices are Pb-Free and are RoHS Compliant

Typical Applications

- Hot Swap Application
- Power Load Switch
- Battery Management and Protection

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	30	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain		$T_C = 25^{\circ}C$	I _D	245	А
Current R _{θJC} (Note 2)	Steady	T _C = 100°C		173	
Power Dissipation $R_{\theta JC}$ (Note 2)	State	T _C = 25°C	PD	124	W
Continuous Drain		T _A = 25°C	۱ _D	43	А
Current R _{θJA} (Notes 1, 2)	Steady	$T_A = 100^{\circ}C$		30	
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)	State	T _A = 25°C	P _D	3.8	W
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	900	А
Source Current (Body Diode)			۱ _S	112	А
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 23.2 \text{ A}$)			E _{AS}	354	mJ
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to + 175	°C
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

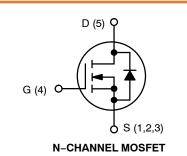
THERMAL RESISTANCE MAXIMUM RATINGS

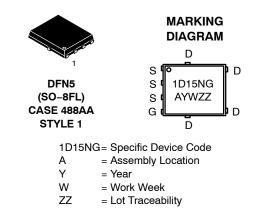
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	1.2	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	40	

1. Surface-mounted on FR4 board using a 1 in², 2 oz. Cu pad.

2. The entire application environment impacts the thermal resistance values shown. They are not constants and are only valid for the particular conditions noted. Actual continuous current will be limited by thermal & electro–mechanical application board design. $R_{\theta CA}$ is determined by the user's board design.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	1.15 m Ω @ 10 V	245 A





ORDERING INFORMATION

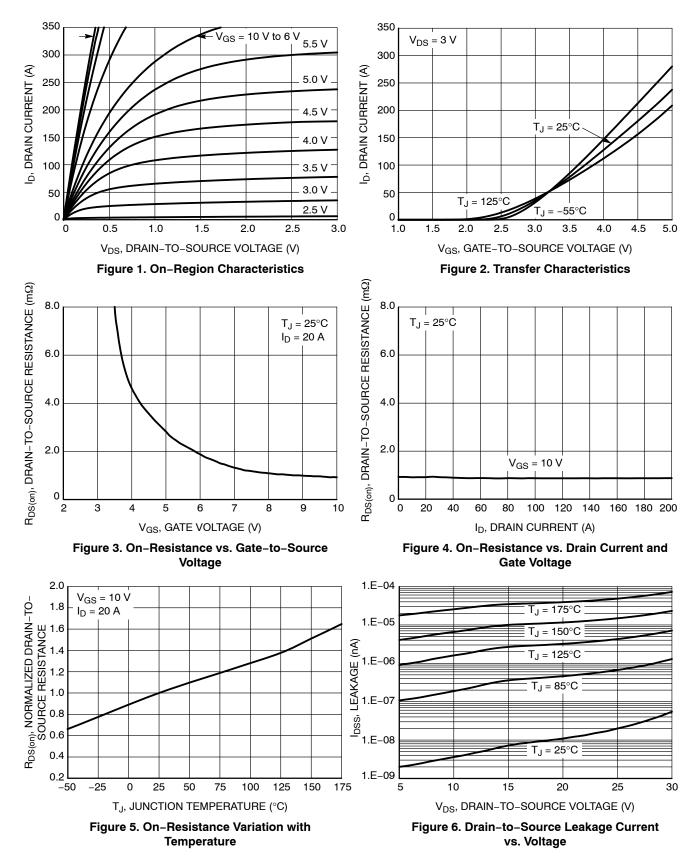
See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

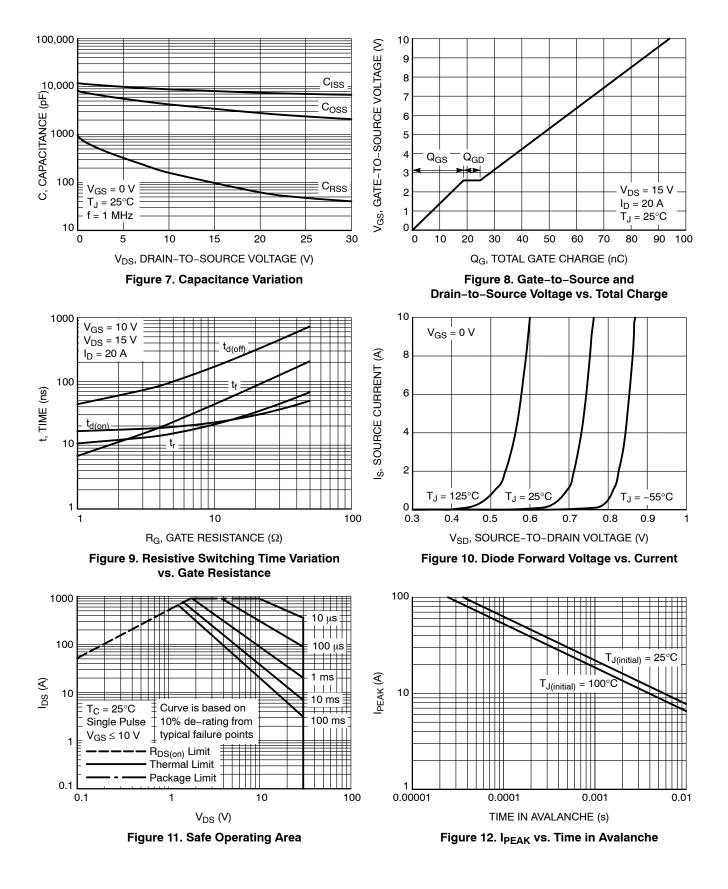
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	I_D = 250 µA, ref to 25°C			14		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$ $T_{J} = 25^{\circ}C$				1.0	
		$V_{DS} = 30 \text{ V}$ $T_{J} =$	T _J = 125°C			100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 160 μ A		1.3		2.2	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	$I_D = 160 \ \mu A$, ref to $25^{\circ}C$			-4.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A			0.92	1.15	mΩ
Forward Transconductance	9fs	V _{DS} = 3 V, I _D = 20 A			61		
Gate Resistance	R _G	T _A = 25°C			1.7		Ω
CHARGES & CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz			7300		pF
Output Capacitance	C _{OSS}				3600		
Reverse Transfer Capacitance	C _{RSS}				99		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 15 V; I _D = 20 A			94		nC
Threshold Gate Charge	Q _{G(TH)}				11		
Gate-to-Source Charge	Q _{GS}				19		
Gate-to-Drain Charge	Q _{GD}				6.9		
SWITCHING CHARACTERISTICS (Note 4	4)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 15 V, I _D = 20 A, R _G = 3 Ω			18		ns
Rise Time	tr				13		
Turn-Off Delay Time	t _{d(OFF)}				72		
Fall Time	t _f				15		
DRAIN-SOURCE DIODE CHARACTERIS	STICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V$, $T_J = 25^{\circ}C$			0.75	1.2	
			$T_J = 125^{\circ}C$		0.60		V
Reverse Recovery Time	t _{RR}	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ V_{DS} = 15 \ V, \ I_S = 20 \ A, \\ dI_S/dt = 100 \ A/\mu s \end{array}$			77		ns
Reverse Recovery Charge	Q _{RR}				102		nC
	•			-	-		-

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 4. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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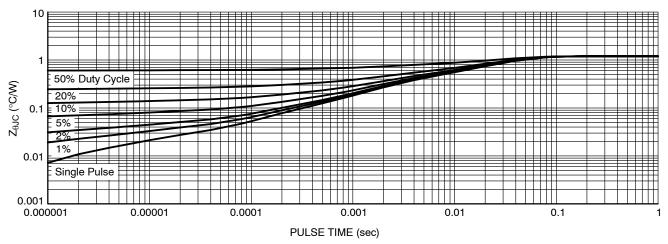


Figure 13. Thermal Impedance

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS1D15N03CGT1G	1D15NG	DFN5 (Pb–Free)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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